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PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6523633

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
YUNBUM LEE	01/21/2021
SEONGBEOM HONG	01/21/2021
KYUNGHOON MOON	01/21/2021
SEUNGGIL JEON	01/21/2021
JAEYOUNG HUH	01/21/2021
JINSANG KIM	01/21/2021
SUNGCHUL PARK	01/21/2021

RECEIVING PARTY DATA

Name:	SAMSUNG ELECTRONICS CO., LTD.
Street Address:	129, SAMSUNG-RO, YEONGTONG-GU
City:	SUWON-SI, GYEONGGI-DO
State/Country:	KOREA, REPUBLIC OF
Postal Code:	16677

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17162110

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 202-293-0804

Email: usdocketing@jeffersonip.com
Correspondent Name: JEFFERSON IP LAW, LLP

Address Line 1: 1130 CONNECTICUT AVE., NW, SUITE 420

Address Line 4: WASHINGTON, D.C. 20036

ATTORNEY DOCKET NUMBER:	0202-1770
NAME OF SUBMITTER:	JOHN A. LEBLANC
SIGNATURE:	/John A. LEBLANC/
DATE SIGNED:	01/29/2021

PATENT REEL: 055077 FRAME: 0899

Total Attachments: 4

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PATENT REEL: 055077 FRAME: 0900

RECORDATION FORM COVER SHEET					
PATENTS ONLY					
To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.					
1. Name of conveying party(ies)	2. Name and address of receiving party(ies)				
1) Yunbum LEE, 2) Seongbeom HONG, 3) Kyunghoon MOON, 4) Seunggil JEON, 5) Jaeyoung HUH, 6) Jinsang KIM, and	Name: Samsung Electronics Co., Ltd.				
7) Sungchul PARK	Internal Address:				
Additional name(s) of conveying party(ies) attached? Yes V No					
3. Nature of conveyance/Execution Date(s):	Street Address: 129, Samsung-ro, Yeongtong-gu				
Execution Date(s) January 21, 2021					
Assignment Merger					
Security Agreement Change of Name	City: Suwon-si, Gyeonggi-do				
Joint Research Agreement	State:				
Government Interest Assignment	Country: Republic of Korea Zip: 16677				
Executive Order 9424, Confirmatory License	Zip. 10077				
Other	Additional name(s) & address(es) attached? Yes V No				
Additional numbers att	ached? ☐ Yes ✔ No				
5. Name and address to whom correspondence	6. Total number of applications and patents				
concerning document should be mailed:	involved: One				
Name: Jefferson IP Law, LLP	7. Total fee (37 CFR 1.21(h) & 3.41) \$				
Internal Address: John A. LeBlanc	Authorized to be charged by credit card				
	Authorized to be charged to deposit account				
Street Address: 1130 Connecticut Ave., NW, Suite 420	Enclosed				
	None required (government interest not affecting title)				
City: Washington	8. Payment Information				
State: District of Columbia Zip:20036	a. Credit Card Last 4 Numbers Expiration Date				
Phone Number: 202-293-0804					
Fax Number: <u>202-403-3587</u>	b. Deposit Account Number Authorized User Name				
Email Address: usdocketing@jeffersonip.com					
9. Signature: /John A. LEBLANC/ Reg. #6	64,611 January 29, 2021				
Signature	Date				
John A. LeBlanc Name of Person Signing	Total number of pages including cover sheet, attachments, and documents:				

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450

REEL: 055077 FRAME: 0901

DOCKET NO.: 0202-1770 CLIENT REF.: SP20272-US IP

SAMSUNG REF.: GM-201910-018-1-US0

Assignment

WHEREAS, the following inventors, namely 1) Yunbum LEE, 2) Seongbeom HONG, 3) Kyunghoon MOON, 4) Seunggil JEON, 5) Jaeyoung HUH, 6) Jinsang KIM, and 7) Sungchul PARK (hereinafter called "Assignors"), having made or discovered certain new, useful and non-obvious improvements in an invention having a working title of:

ELECTRONIC DEVICE INCLUDING ANTENNA MODULE TO WHICH DIELECTRIC SHEET IS ATTACHED,

for which a United States Patent Application is being filed concurrently herewith or, if not being concurrently filed, was filed on <u>January 29, 2021</u>, and assigned Serial No. <u>17/162,110</u>; and,

WHEREAS, Samsung Electronics Co., Ltd., a corporation duly organized under the laws of the Republic of Korea, located and doing business at 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea, 16677 (hereinafter called "Assignee"), is desirous of acquiring the entire right, title and interest therein;

NOW, THEREFORE, BE IT KNOWN that for and in good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, Assignors do hereby sell, assign and transfer unto said Assignee the entire and exclusive worldwide right, title and interest in and to all said inventions and discoveries disclosed in said application, and in and to said application, any and all substitutions, divisions, provisionals, conversions of provisionals and continuations thereof, and in and to all Letters Patent, United States and all other foreign countries, that may be granted for said inventions and discoveries, and in and to all extensions. renewals and reissues thereof; and the right to file any other foreign country application and/or claim priority under the provisions of any international treaty or convention arising from this application or any divisional, continuing, substitute or reissue application therefrom. The aforesaid assignment includes the right in and to all income, royalties, damages and payments, now or hereafter due or payable with respect to any Letters Patent which may be granted, and in and to all causes of action (either in law or in equity), and the right to sue, counterclaim, and recover for past, present and future infringement of the rights assigned or to be assigned under this Assignment, as fully and entirely as the same would have been held and enjoyed by Assignors if this sale, assignment and transfer had not been made.

Assignors covenant and agree, without further compensation to said Assignors but at Assignee's expense:

- a. to execute:
 - all papers to be used in connection with this application and any divisional, continuing, substitute or reissue application thereof, as the Assignee may deem necessary or expedient, and
 - all papers in connection with any interference, litigation, mediation, arbitration or other proceeding relating to this application or any divisional, continuing, substitute or reissue application thereof, as may be necessary or expedient;

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DOCKET NO.: 0202-1770 CLIENT REF.: SP20272-US_IP

SAMSUNG REF.; GM-201910-018-1-US0

b. to cooperate with the Assignee in every way possible in obtaining evidence and going forward in any interference, litigation, mediation, arbitration or other proceeding relating to said invention, said application and any divisional, continuing, substitute or reissue application thereof;

- c. to communicate to the Assignee any facts relating to said invention, said application and any divisional, continuing, substitute or reissue application thereof, including evidence for any interference, litigation, mediation, arbitration or other proceeding relating to said invention, whenever requested;
- d. to testify in any interference, litigation, mediation, arbitration or other proceeding relating to said invention, said application and any divisional, continuing, substitute or reissue application thereof whenever requested; and
- e. to perform all other affirmative acts which may be necessary or desirable to secure full and complete protection of the inventions and discoveries or that may be necessary or desirable to vest in Assignee the complete title to the inventions and discoveries and Letters Patent hereby conveyed and to enable Assignee to record title.

Assignors hereby authorize and request the United States Patent and Trademark Office or any other issuing authority to issue any and all Letters Patent that may be granted upon this invention and/or this application or any divisional, continuing, substitute or reissue application thereof to the Assignee, its legal representatives, successors and assigns.

Assignors each hereby represents, covenants and warrants that he or she has the full right to convey the entire right, title and interest by this instrument, free of any encumbrances and that no other agreement has been or will be executed in conflict herewith.

The provisions of this Assignment are binding upon Assignors' heirs, legal representatives and/or administrators and assigns.

Assignors hereby grant to the law firm of Jefferson IP Law, LLP of Washington, DC and its attorneys and agents as associated with Customer No. 68103 the authority and power to insert on this instrument any further identification which may be necessary or desirable for purposes of recordation in the United States Patent and Trademark Office or a Patent Office of any foreign country.

PATENT REEL: 055077 FRAME: 0903 DOCKET NO.: 0202-1770 CLIENT REF.: SP20272-US IP

SAMSUNG REF.: GM-201910-018-1-US0

Signature of Inventor:	Yunbum LEE	2021. 1. 21 Date
Signature of Inventor:	Seongbeom HONG	<u> との シェ (、</u> と Date
Signature of Inventor:	Kyunghoon MOON	Date 1, 21
Signature of Inventor:	Seunggil JEON	<u> </u>
Signature of Inventor:	Jae yowy HUM Jacyoung HUH	
Signature of Inventor:	Jinsang KIM	<u>2v2/ . / , V</u> Date
Signature of Inventor:	Sungchul PARK	21. JAN 202 Date